

Wide Vin 50V Non-synchronous Boost/Flyback/SEPIC Controller

FEATURES

- Qualified for Automotive Applications
- AEC-Q100 Qualified with the Following Results:
 - Device Temperature Grade 1: -40°C to 125°C
 - Ambient Operating Temperature Range
 - Device HBM ESD Classification Level H2
 - Device CDM ESD Classification Level C3B
- Wide Input Voltage Range: 3.2V-50V
- Low Shutdown Current 3.7uA
- Low Quiescent operating Current: 450uA
- Adjustable Switching Frequency: 100KHz to 2.2MHz
- Integrated Frequency Dithering for EMI Mitigation
- External Frequency Synchronic
- External Compensation
- Supports additional Slope Compensation
- 22ms Internal Soft-start Time
- Integrated Protection Feature
 - Constant Peak-Current Protection Threshold
 - Over Input Voltage
 - Output Overvoltage Protection
 - Adjust Under-Voltage Lockout
 - Optional Hiccup Over Load Protection
 - Thermal Shutdown Protection: 165°C
- MSOP-8L(3mm*3mm) Package

APPLICATIONS

- Muti-output Flyback
- LED Bias Supply
- Portable Speaker Supply
- Battery Powered Boost/Flyback/SEPIC application

SCT81620Q

REVISION HISTORY

Revision 1.1: Update Device Order Information

DEVICE ORDER INFORMATION

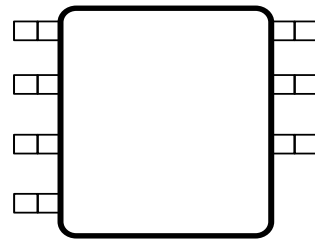
ORDERABLE DEVICE	PACKAGING TYPE	STANDARD PACK QTY	PACKAGE MARKING	PINS	PACKAGE DESCRIPTION
SCT81620QMTDR	Tape & Reel	4000	1620Q	8	8-Lead 3mm×3mm Plastic MSOP

ABSOLUTE MAXIMUM RATINGS

Over operating free-air temperature unless otherwise noted⁽¹⁾

DESCRIPTION	MIN	MAX	UNIT
VIN	-0.3	62	V
DR	-1	6.6	V
ISEN, COMP, FB, FA/SYNC/SD	-5	5.5	V
Peak Driver Output Current		1 ⁽²⁾	A
Junction temperature ⁽²⁾	-40	150	C

PIN CONFIGURATION



Top View: 8-Lead Plastic MSOP 3mmx3mm

V _{IN}	8	Power supply input pin
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RECOMMENDED OPERATING CONDITIONS

Over operating free-air temperature range unless otherwise noted

PARAMETER	DEFINITION	MIN	MAX	UNIT
V _{IN}	Input voltage range	3.2	50	V
V _{CC}	VCC voltage range	3.2	6.1	V
T _J	Operating junction temperature	-40	125	°C

ESD RATINGS

PARAMETER	DEFINITION	MIN	MAX	UNIT
V _{ESD}	Human Body Model(HBM), per ANSI-JEDEC-JS-001-2014 specification, all pins	-2	+2	kV

SCT81620Q

ELECTRICAL CHARACTERISTICS

$V_{IN}=12V$, $T_J=-40^{\circ}C\sim 125^{\circ}C$, typical values are tested under $25^{\circ}C$.

SYMBOL

TYPICAL CHARACTERISTICS

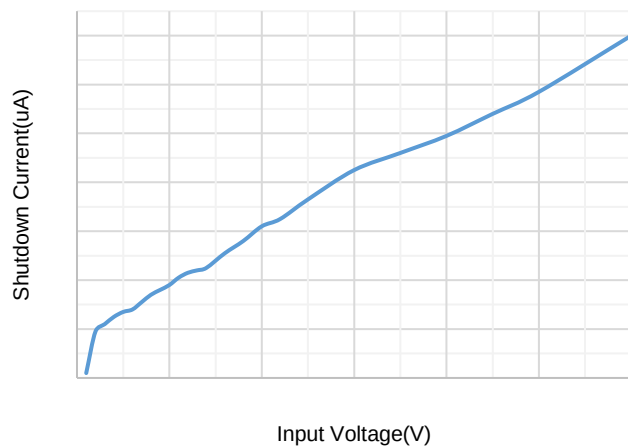


Figure 1. ISD vs Input Voltage

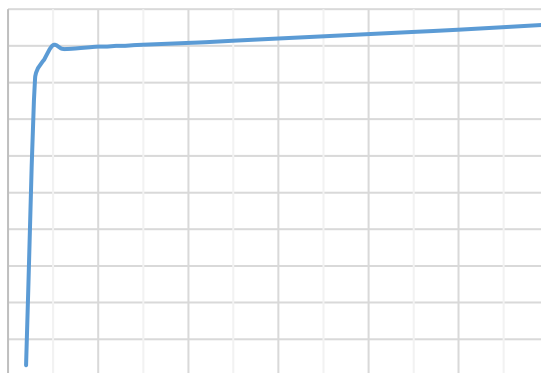


Figure 2. IQ vs Input Voltage

Figure 3. Switching Frequency vs RT

Figure 4. Switching Frequency vs Temperature

Figure 5. Efficiency vs Load Current, Boost, VOUT=12V

Figure 6. Efficiency vs Load Current, Sepic, VOUT=12V

TYPICAL CHARACTERISTICS

Figure 7. VSENSN vs Input Voltage

Figure 8. DR Volage vs Input Voltage

Figure 9. COMP

FUNCTIONAL BLOCK DIAGRAM

$$V_{smp} = I_L * R_{SEN} \quad (1)$$

$$M_1 = M_{on} * R_{SEN} \quad (2)$$

$$M_2 = M_{off} * R_{SEN} \quad (3)$$

$$M_1 = M_{on} * R_{SEN} \quad V_{in} * R_{SEN} / L \quad (4)$$

$$M_2 = M_{off} * R_{SEN} \quad (V_{out} - V_{in}) * R_{SEN} / L \quad (5)$$

$$V_{smp1} = \left(\frac{M_2}{M_1} \right) * V_{smp0} \quad (6)$$

$$V_{smp1} = \left(\frac{M_2}{M_1} \right) * V_{smp0} \quad \left(\frac{D}{1-D} \right) * V_{smp0} \quad (7)$$

$$\left| \left(\frac{M_2}{M_1} \right) \right| < 1 \quad (8)$$

$$M_c = V_{SL} * F_s \quad (9)$$

$$M_c = (V_{SL} - K * R_{SL}) * F_s \quad (10)$$

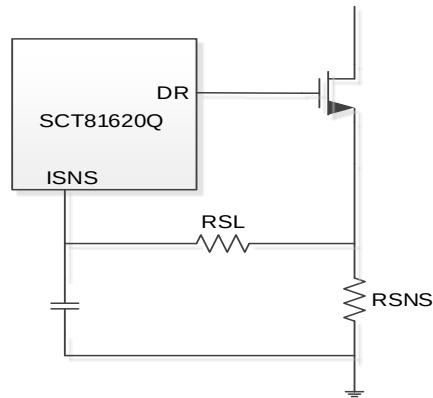


Figure13 .External RSL to increase slope compensation

Adjustable Peak Current Limit

$$I_{PEAK_CL} = \frac{V_{SENSE} \cdot 40\mu A \cdot R_{SL} \cdot D}{R_{SNS}} \quad (11)$$

Where

- VSENSE is ISEN pin limiting voltage (Typ.=146.5mV)
- IPEAK-CL is the inductor peak current limit
- RSL is Slope compensation resistor
- D is Duty cycle
- RSNS is the Inductance peak current detection resistance

Output Voltage

$$R_{FBT} \frac{V_{OUT} V_{REF}}{V_{REF}} R_{FBB}$$

APPLICATION INFORMATION

Typical Application (Boost)

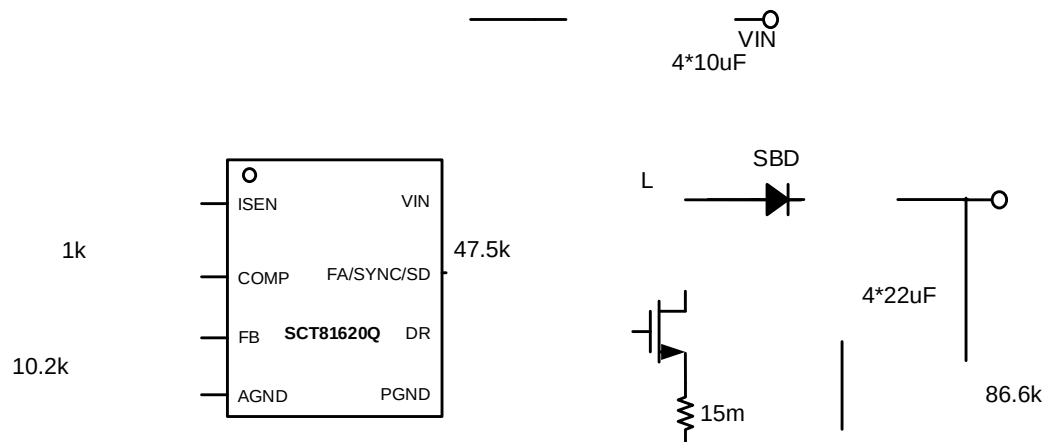


Figure 19. Application Schematic, 3V to 11V, 2A Boost Regulator at 400kHz

Design Parameters

Design Parameters	Example Value
Input Voltage	5V Normal 3V to 11V
Output Voltage	12V
Maximum Output Current	3A
Switching Frequency	400 KHz
Output voltage ripple (peak to peak)	75mV (Load=2A)

Inductor Selection (Boost)

$$= \frac{x}{x} \quad (14)$$

Where

V_{OUT} is the output voltage of the boost converter

I_{OUT} is the output current of the boost converter

V_{IN} is the input voltage of the boost converter

$$= \frac{1}{x \left(\frac{1}{-} + \frac{1}{-} \right) x} \quad (15)$$

Where

I_{LPP} is the inductor peak-to-

Where

I_G is the gate drive current.

Output Diode Selection

$$I_{D(PEAK)} = \frac{I_{OUT}}{(1 - D)} + I_L \quad (24)$$

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Application Waveforms

Vin=5V, Vout=12V, unless otherwise noted

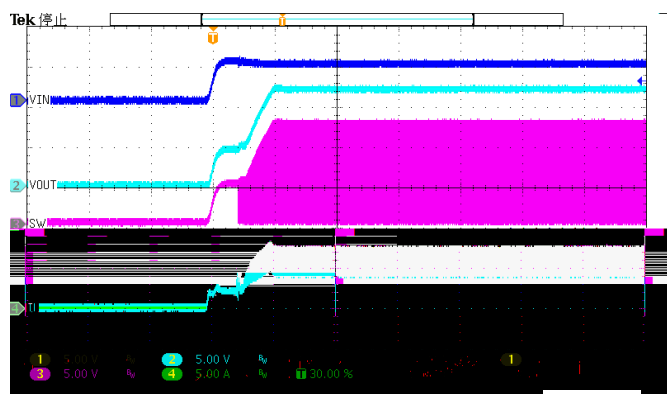


Figure 20. Power up(Iload=2A)

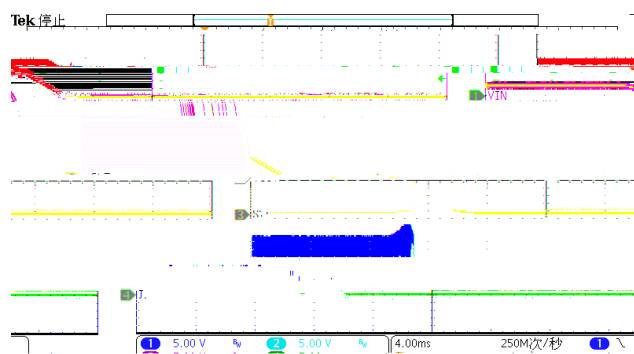


Figure 21. Power down(Iload=2A)

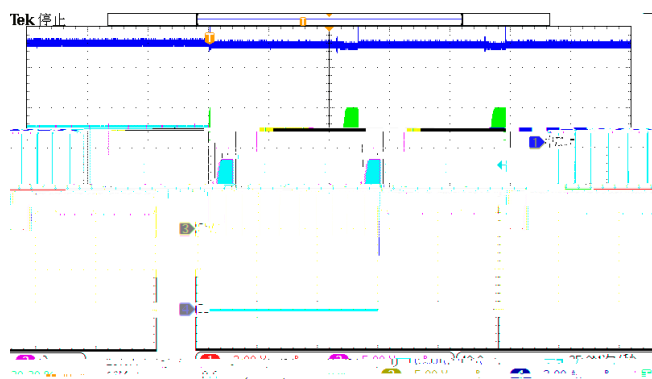


Figure 22. Over current protection (Iload=5A)

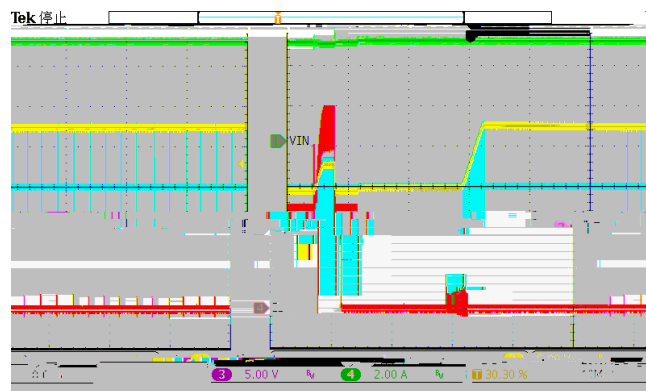


Figure 23. Over current recovery (Iload=5A)

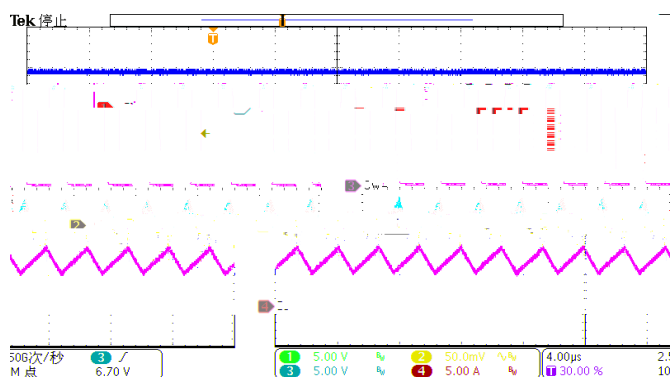


Figure 24. Steady-state (Iload=2A)

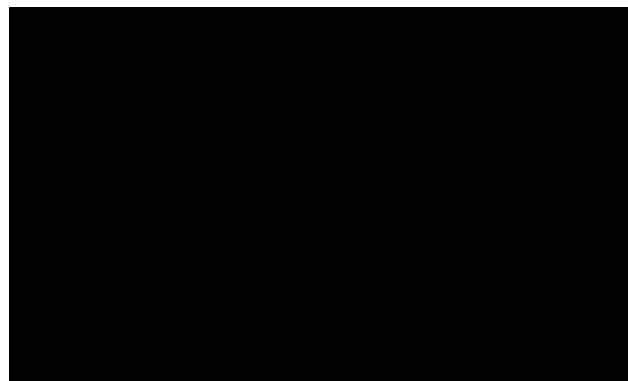
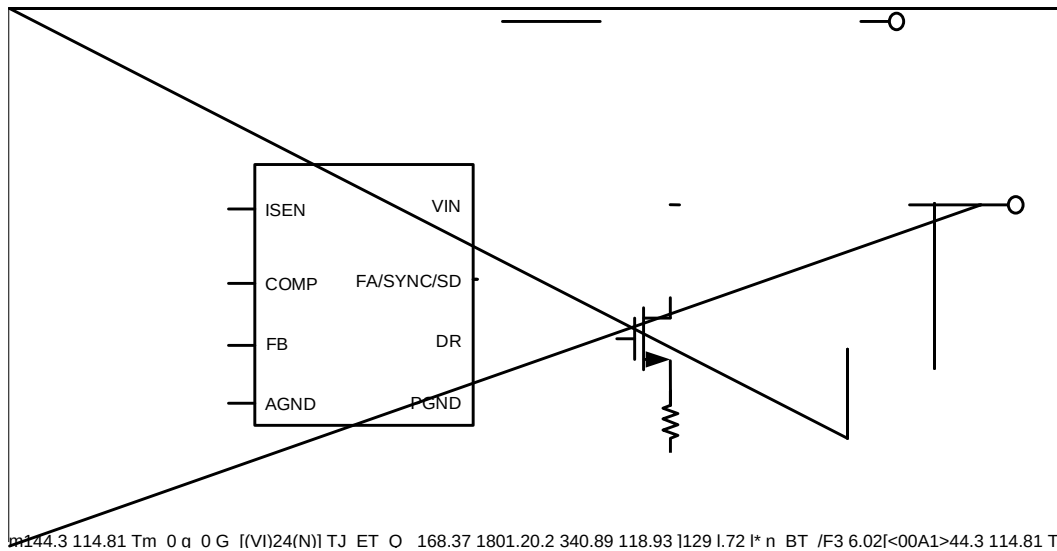


Figure 25. Sync Frequency

Typical Application (Sepic)



Design

Inductor Selection (Sepic)

$$I_{L1_PEAK} = I_{IN} + 40\% = I_O \frac{V_O}{V_{IN_MIN}} + 40\% \quad (25)$$

(26)

$$L = \frac{V_{IN_MIN}}{I_L f_{SW}} D_{MAX} \quad (27)$$

f_{SW} is the switching frequency.

$$I_{L1_PEAK} = I_{IN} + \frac{I_L}{2} = I_O \frac{V_O}{V_{IN_MIN}} + (1 + \frac{40\%}{2}) \quad (28)$$

$$I_{L2_PEAK} = I_O + \frac{I_L}{2} = I_O (1 + \frac{40\%}{2}) \quad (29)$$

$$I_{COUT_RMS} = I_O \sqrt{1 + \frac{D_{MAX}}{D_{MAX}}}$$
(41)

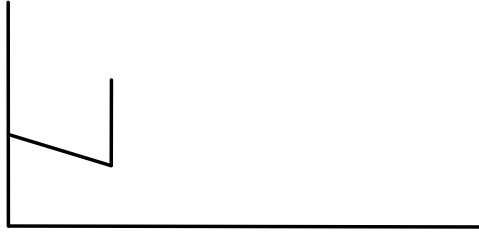


Figure 27. Output Voltage Ripple

Application Waveforms

Vin=5V, Vout=12V, unless otherwise noted

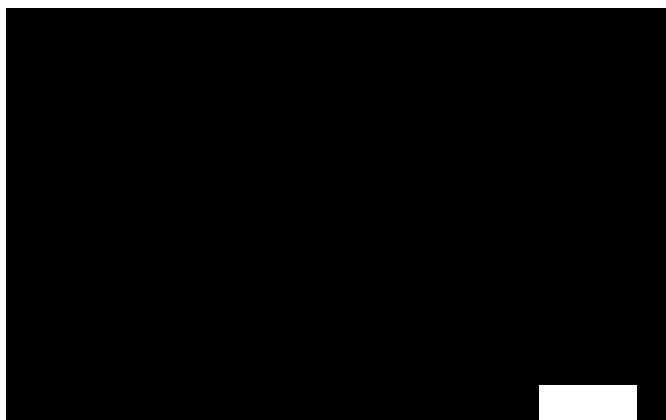


Figure 28. Power up(Iload=2A)

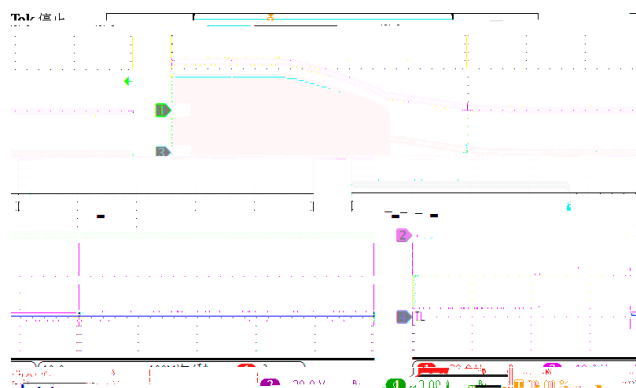


Figure 29. Power down(Iload=2A)

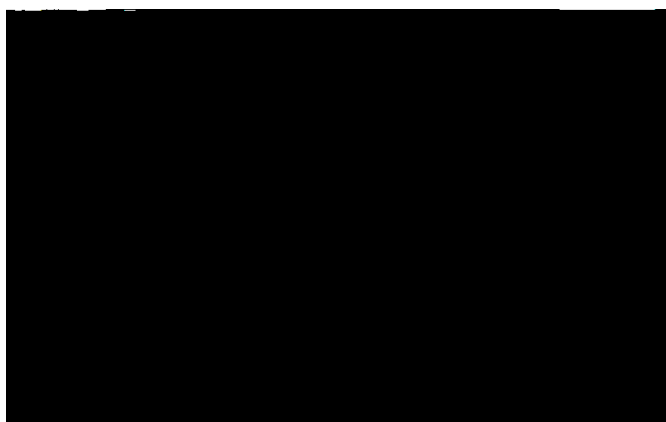


Figure 30. Shutdown remove

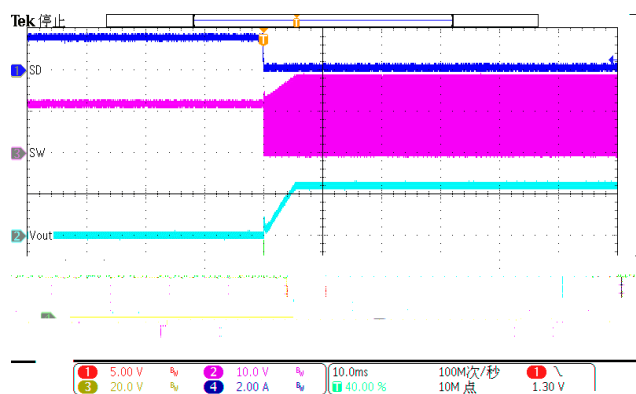


Figure 31. Shutdown remove

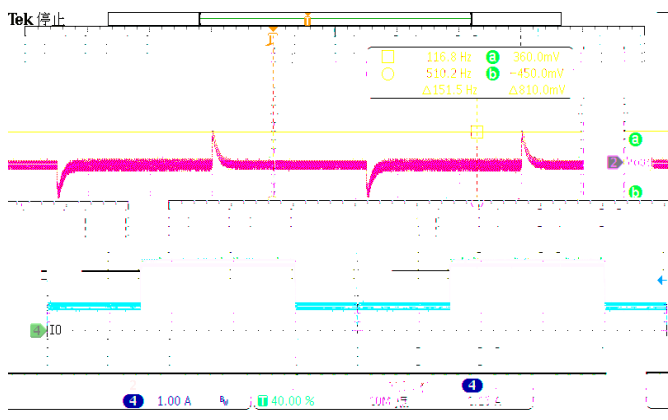


Figure 32. LoadTrans (Iload=0.5A-1.5A)

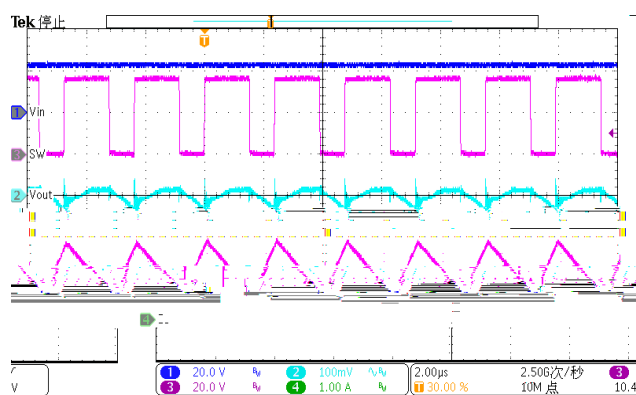


Figure 33. steady-state (Iload=2A)

Layout Guideline

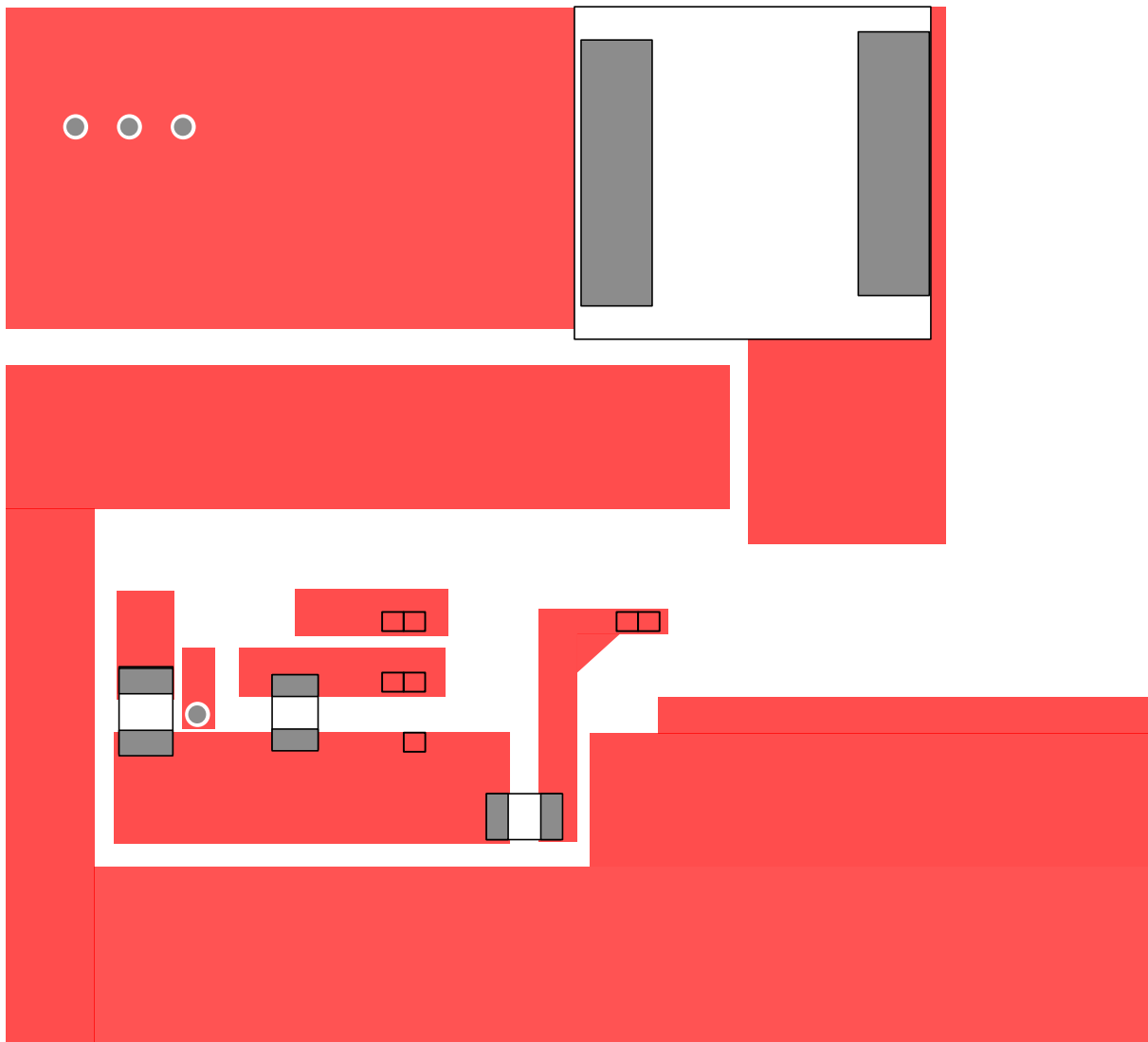
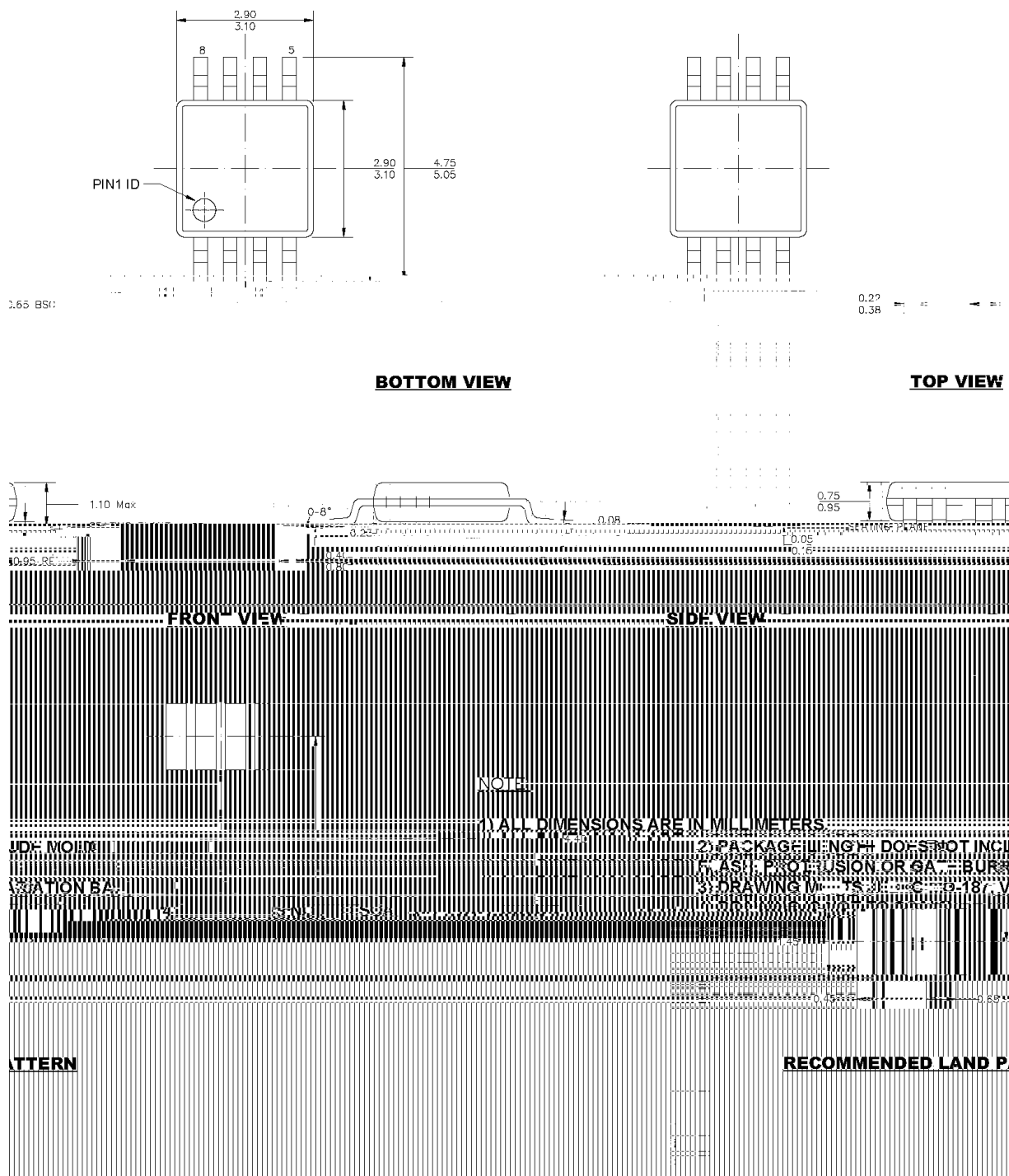
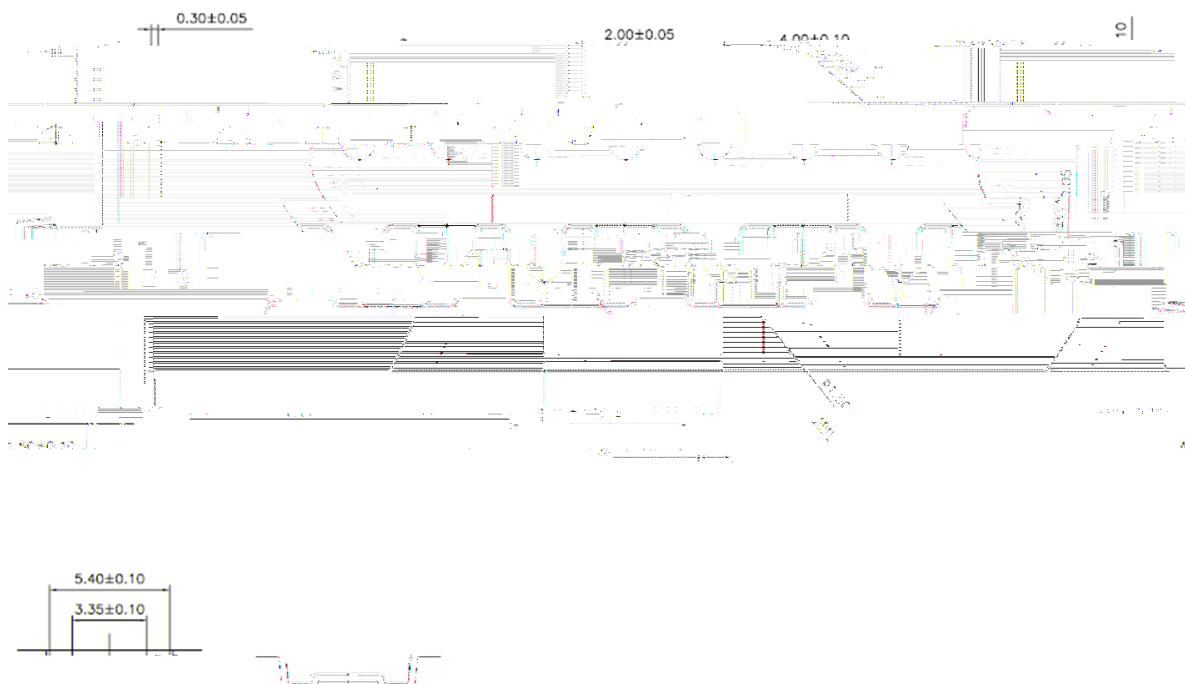


Figure 34. BOOST PCB Layout

PACKAGE INFORMATION



TAPE AND REEL INFORMATION



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